

Type CRGP Series

Key Features

Key Features

Small size and light weight

Suitable for both wave and reflow soldering techniques

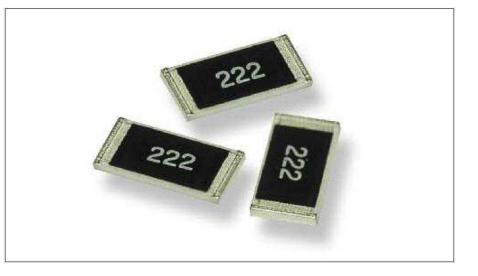
Supplied on tape

Pulse Rated

7 different package sizes

Terminal finish matte Sn over Ni

AEC-Q200 Compliant



TE Connectivity is pleased to introduce this SMD Pulse withstand thick film Chip resistor, suitable for auto placement in volume and for most applications. Available in five different packages and supplied on tape and reel for automatic insertion processes. Standard values – E24 Series and now AEC-Q200 Qualified

Characteristics – Electrical

Туре	CRGP0402	CRGP0603	CRGP0805	CRGP1206		
Power Rating @ 70°C	0.125W	0.25W	0.33W	0.5W		
Max. Working Voltage	50V	50V	150V	200V		
Max. Overload Voltage	100V	100V	300V	400V		
Dielectric Withstand	100V	300V	500V	500V		
Temperature Range		-55°C	~ +155°C			
Ambient Temperature	70°C					

Туре	CRGP1210	CRGP2010	CRGP2512		
Power Rating @ 70°C	0.75W	1.25W	2W		
Max. Working Voltage	200V	400V	500V		
Max. Overload Voltage	500V	800V	1000V		
Dielectric Withstand	500V	500V	500V		
Temperature Range	-55°C ~ +155°C				
Ambient Temperature	70°C				

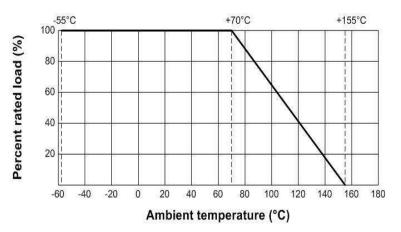
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Dimensions in millimetres unless otherwise specified Dimensions Shown for reference purposes only. Specifications subject to change

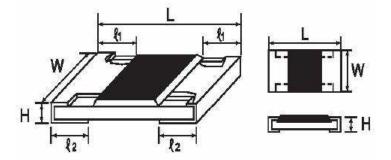


Power derating curve

Power rating based on continuous load operation in ambient temperature of 70°C. For resistors operated in ambient temperatures above 70°C, power rating must be derated in accordance with this curve.



Dimensions:



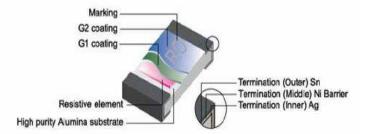
Turno		Dimension (mm)									
Туре	L	W	н	£1	£2						
CRGP0402	1.10±0.10	0.50±0.05	0.35±0.05	0.20±0.10	0.25±0.10						
CRGP0603	1.60±0.10	0.80±0.10	0.45±0.10	0.30±0.20	0.30±0.20						
CRGP0805	2.00±0.15	1.25+0.15	0.55±0.10	0.40±0.20	0.40±0.20						
		-0.10									
CRGP1206	3.10±0.15	1.55+0.15	0.55±0.10	0.45±0.20	0.45±0.20						
		-0.10									
CRGP1210	3.10±0.10	2.60±0.20	0.55±0.10	0.55±0.25	0.50±0.20						
CRGP2010	5.00±0.10	2.50±0.20	0.55±0.10	0.60±0.25	0.50±0.20						
CRGP2512	6.35±0.10	3.20±0.20	0.55±0.10	0.60±0.25	0.50±0.20						

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Construction:

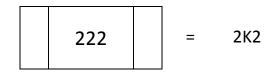


Power Rating and Resistance Range:

Туре	Power Rating @ 70°C	Tolerance	Resistance Range	Standard Series
		±1%		E24
CRGP0402	0.125W	±5%	1R0 – 10M	E96 by
				negotiation
		±1%		E24
CRGP0603	0.25W	±5%	1R0 – 10M	E96 by
				negotiation
		±1%		E24
CRGP0805	0.33W	±5%	1R0 – 10M	E96 by
				negotiation
		±1%		E24
CRGP1206	0.5W	±5%	1R0 – 10M	E96 by
				negotiation
		±1%		E24
CRGP1210	0.75W	±5%	1R0 – 10M	E96 by
				negotiation
		±1%		E24
CRGP2010	1.25W	±5%	1R0 – 10M	E96 by
				negotiation
		±1%		E24
CRGP2512	2W	±5%	1R0 – 10M	E96 by
				negotiation

Marking:

E24 series 0603 – 2512 3 Digits – first two digits denote significant figures of resistance and third digit denotes number of zeros thereafter. EG

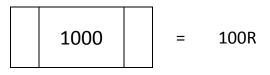


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Marking for E96 Series 0805 – 2512 4 digits – First three digits denote significant figures of resistance and fourth digit denotes number of zeros thereafter. EG.



For ohmic values below 100R letter "R" denotes decimal point. EG

0402 size chips are not marked

0603 E96 3 digit marking.

Mutiplier Code :

Code	A	В	С	D	E	F	G	H	X	Y	Z
	0	1	2	3	4	5	6	7	-1	-2	-3
Multiplier	10	10	10	10	10	10	10	10	10	10	10

Coding XX		Formula X	Example :	10.2K ()	} =	102 ↓ 02	x	10 Ω ↓ c		02C
	Resistance Code		Multiplier Code	33.2 Ω	=	332 ↓ 51	x	-1 10 Ω ↓ X	=	51X

Value	Code								
100	01	162	21	261	41	422	61	681	81
102	02	165	22	267	42	432	62	698	82
105	03	169	23	274	43	442	63	715	83
107	04	174	24	280	44	453	64	732	84
110	05	178	25	287	45	464	65	750	85
113	06	182	26	294	46	475	66	768	86
115	07	187	27	301	47	487	67	787	87
118	08	191	28	309	48	499	68	806	88
121	09	196	29	316	49	511	69	825	89
124	10	200	30	324	50	523	70	845	90
127	11	205	31	332	51	536	71	866	91
130	12	210	32	340	52	549	72	887	92
133	13	215	33	348	53	562	73	909	93
137	14	221	34	357	54	576	74	931	94
140	15	226	35	365	55	590	75	953	95
143	16	232	36	374	56	604	76	976	96
147	17	237	37	383	57	619	77	0	
150	18	243	38	392	58	634	78		
154	19	249	39	402	59	649	79		
158	20	255	40	412	60	665	80		

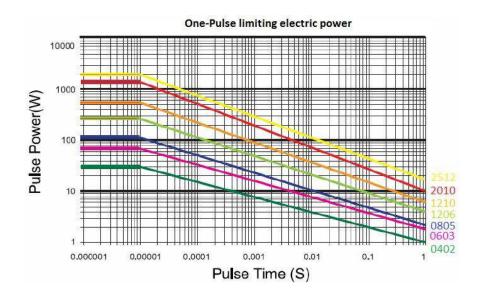
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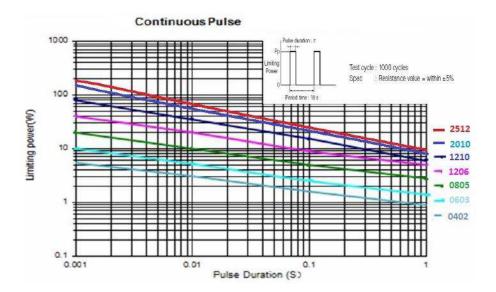
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Pulse withstand capacity

The single impulse graph is the result of 50 impulses of rectangular shape applied at one-minute intervals. The limit of acceptance was a shift in resistance of less than 1% from the initial value. The power applied was subject to the restrictions of the maximum permissible impulse voltage graph shown.





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Performance Specification:

Characteristic	Limits	Test Methods
Characteristic	LIIIIILS	
		(AEC-Q200)
Operational	±5%, ±10%, ±20%:	125°C, at35% of operating power,
life	±(3%+0.1Ω)Max.	1000H(1.5 hours
		"ON", 0.5 hour "OFF"). (MIL-STD-202)
Temperature	1Ω~10Ω : ± 400 PPM/°C	Natural resistance change per temp.
Coefficient	10.1Ω~10MΩ : ± 100	degree centigrade
	PPM/°C	R1-R2
		x10 ⁶ (PPM/°C)
		R1(t2-t1)
		R1 resistance value at room temperature
		(t1)
		R2 Resistance value at room temperature
		+100°C (t2)
External Visual	No Mechanical Damage	Electrical test not required. Inspect device
	No Mechanica Danage	construction, marking and workmanship
Dhysical	Reference 2.0 Dimension	(MIL-STD-883 Method 2009)
Physical Dimensions	Standards	Verify physical dimensions to the
Dimensions	Standards	applicable device detail specification.
		Note: User(s) and Suppliers spec. Electrical
		test not required.
D · · · · ·		(JESD22 MH Method JB-100)
Resistance to	Marking Unsmeared	Note: Add Aqueous wash chemical – OKEM
Solvent		Clean or equivalent.
		Do not use banned solvents.
		(MIL-STD-202 Method 215)
Terminal	Not Broken	Force of 1.8kg for 60 seconds.
Strength		(JIS-C-6429)
Terminal	± (1.0% ±0.05Ω) Max.	Twist of Test Board :
Bending		Y/X = 5/90 mm for 10 seconds
		(Sub-clause 4.33)
High	±(1%+0.1Ω)max	1000hrs. @T=155°C.Unpowered.
Temperature		Measurement at 24±2 hours after test
Exposure		conclusion. (MIL-STD-202 Method 108)
(Storage)		
Temperature	Resistance change rate is	1000 Cycles (-55°C to +155°C).
Cycling	±5%, ±10%, ±20%: ±	Measurement at 24±2 hours after test
	(1.0%+0.1Ω) Max.	conclusion.
		(JESD22 Method JA-104)
Solderability	95% coverage Min.	Test temperature of solder : 245 ± 3 °C
		Dwell time in solder : 2 ~ 3 seconds
		(Sub-clause 4.17)
		For both leaded & SMD. Electrical test not
		required.
		95% coverage Min. Magnification 50X.
		Conditions:
		(J-STD-002)
Soldering Heat	Resistance change rate is	Dip the resistor into a solder bath having a
5	±(1.0%+0.05Ω) Max.	temperature of 260°C±3°C and hold it for
	. ,	10±1 seconds
		(Sub-clause 4.18)
Insulation	1,000MΩ or more	Apply 500V DC between protective coating
Resistance	,	and termination for 1 min, then measure
		(Sub-clause 5.6)
	I	(

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Characteristic	Limits	Test Methods						
		(AEC-Q200)						
Solder Temp.	Electrical characteristics	Wave soldering condition: (2 cycles Max.)						
Reference	shall be satisfied without	Pre-heat : $100 \approx 120 $ °C, 30 ± 5 sec.						
herenee	distinct deformation in	Suggestion solder temp.: 235 ~ 255 °C, 10						
	appearance.	seconds max.						
	(95% coverage Min.)	Peak temp.: 260 °C						
	(Sove coverage mini)	Reflow soldering condition: (2 cycles Max.)						
		Pre-heat : 150 ~ 180 °C, 90 ~ 120 sec.						
		Suggestion solder temp.: 235 ~ 255 °C, 20 ~						
		40 sec.						
		Peak temp.: 260 °C						
		(°C) Peak: 260°C (Max)						
		250 235°C - 255°C						
		200 Pre Heating Zone						
		150 150 °C						
		90 ~ 120 sec						
		100 20-40 sec						
		Soldering Zone						
		50 Heating time						
		Temperature profile for avaluation						
		Hand Soldering 300°C 5 seconds						
Short term	Resistance change rate is	Permanent resistance change after the						
overload	$\pm 5\%$: $\pm (2.0\% \pm 0.1\Omega)$ Max.	application of a potential of 2.5 times						
ovenoad	$\pm 1\%$: $\pm (1.0\% \pm 0.1\Omega)$ Max.	RCWV for 5 seconds						
	±1/0 : ±(1.0/0 ±0.132) Wax.	Sub-clause 4.13						
Dielectric	No evidence of flashover,	Apply 500V AC between protective coating						
Withstand	mechanical damage,	and termination for 1 minute						
Voltage	arcing or insulation	(Sub-clause 4.7)						
Voltage	breakdown.							
Humidity	Resistance change rate is:	Temporary resistance change after 240						
Trainiarty	$\pm (3.0\% + 0.1\Omega)$ Max.	hours exposure in a humidity test chamber						
		controlled at 40±2°C and 90-95% relative						
		humidity						
		(Sub-clause 4.24)						
Load Life In	Resistance change rate is:	Resistance change after 1,000 hours (1.5						
Humidity	$\pm 5\%$: ±(3.0% ±0.1Ω) Max.	hours "on", 0.5 hour "off") at RCWV in a						
inditionally	$\pm 1\%$: ±(1.0% ±0.1Ω) Max.	humidity chamber controlled at $40^{\circ}C \pm 2^{\circ}C$						
		and 90 to 95 % relative humidity.						
		(Sub-clause 4.24.2.1)						
Load Life	Resistance change rate is:	Permanent resistance change after 1,000						
	$\pm 5\%$: ±(3.0% ±0.1Ω) Max.	hours operating at RCWV, with duty cycle						
	$\pm 1\%$: ±(1.0% ±0.1Ω) Max.	of (1.5 hours "on", 0.5 hour "off") at 70°C \pm						
	±1/0 . ±(1.0/0 ±0.132) IVIdX.	2°C ambient						
		(Sub-clause 4.25.1						
	l	(Jub-clause 4.23.1						

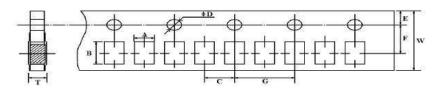
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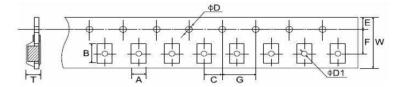
Packaging Specification

Paper taping



Туре	A ±	В±	C ±	ØD +0.1	Е±	F±	G ±	W ±	Τ±
	0.2	0.2	0.05	-0	0.1	0.05	0.1	0.2	0.1
0402	0.65	1.15	2.0	1.5	1.75	3.5	4.0	8.0	0.45
0603	1.10	1.90	2.0	1.5	1.75	3.5	4.0	8.0	0.67
0805	1.65	2.40	2.0	1.5	1.75	3.5	4.0	8.0	0.81
1206	2.00	3.60	2.0	1.5	1.75	3.5	4.0	8.0	0.81
1210	2.80	3.50	2.0	1.5	1.75	3.5	4.0	8.0	0.75

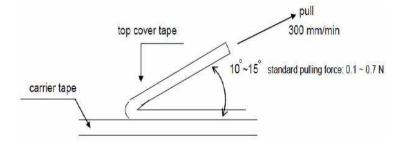
Embossed Taping



Туре	А	В	С	ØD	ØD1	E	F	G	W	Τ±
	±0.2	±0.2	±0.05	+0.1	+0.1	±0.1	±0.05	±0.1	±0.2	0.1
				-0	-0					
2010	2.90	5.60	2.0	1.5	1.5	1.75	5.5	4.0	12.0	1.0
2512	3.50	6.70	2.0	1.5	1.5	1.75	5.5	4.0	12.0	1.0

Peeling strength of cover tape:

Test condition: 0.1 to 0.7 N at a peel off speed of 300mm / min.

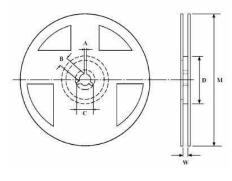


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Reel Dimensions (mm):



Туре	Таре	Reel	A ± 0.5	B ± 0.5	C ± 0.5	D ± 1	M ± 2	W ± 1
		Qty						
0402	Paper	10,000	2	13	21	60	178	10
0603	Paper	5,000	2	13	21	60	178	10
0805	Paper	5,000	2	13	21	60	178	10
1206	Paper	5,000	2	13	21	60	178	10
1210	Paper	5,000	2	13	21	60	178	10
2010	Embossed	4,000	2	13	21	60	178	13.8
2512	Embossed	4,000	2	13	21	60	178	13.8

Environment Related Substance

This product complies to EU RoHS directive, EU PAHs directive, EU PFOS directive and Halogen free.

Ozone layer depleting substances.

Ozone depleting substances are not used in our manufacturing process of this product.

This product is not manufactured using Chloro fluorocarbons (CFCs), Hydrochlorofluorocarbons (HCFCs), Hydrobromofluorocarbons (HBFCs) or other ozone depleting substances in any phase of the manufacturing process.

Storage Condition

The performance of these products, including the solderability, is guaranteed for a year from the date of arrival at your company, provided that they remain packed as they were when delivered and stored at a temperature of 25° C \pm 10° C and a relative humidity of 60%RH \pm 10%RH, chemical and dust free atmosphere

Even within the above guarantee periods, do not store these products in the following conditions otherwise, their electrical performance and/or solderability may be deteriorated, and the packaging materials (e.g. taping materials) may be deformed or deteriorated, resulting in mounting failures.

1. In salty air or in air with a high concentration of corrosive gas, such as Cl2, H2S, NH3, SO2, or NO2

2. In direct sunlight

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Solder Profile

Wave soldering condition: (2 cycles Max.)

Pre-heat : 100 ~ 120 °C, 30 ± 5 sec.

Suggestion solder temp.: 235 ~ 255 °C, 10 seconds

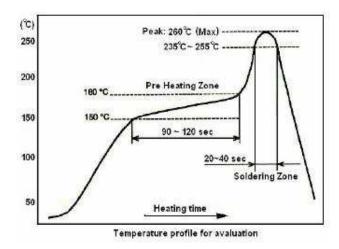
Peak temp.: 260 °C

Reflow soldering condition: (2 cycles Max.)

Pre-heat : 150 ~ 180 °C, 90 ~ 120 sec.

Suggestion solder temp.: 235 ~ 255 °C, 20 ~ 40 seconds

Peak temp.: 260 °C



Hand Soldering condition: The Soldering iron tip should be less than 300°C and maximum contact time should be 5 seconds

How To Order

CRGP	0603	J	10K
Common Part	Size	Tolerance	Resistance Value
CRGP – Pulse Withstand Thick Film Chip Resistor	0402 0603 0805 1206 1210 2010 2512	F - ±1% J - ±5%	1 ohm (1Ω) 1R0 1K ohm (1000Ω) 1K0 100K ohm (100000Ω) 100K 1M ohm (1000000Ω) 1M0

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 M55342K06B309DRS3
 M55342K06B6E81RS3
 M55342K08B100DRWB
 M55342M05B200DRWB
 MC0603-511-JTW
 742C083750JTR

 MCR01MZPF1202
 MCR01MZPF1601
 MCR01MZPF1800
 MCR01MZPF6201
 MCR01MZPF9102
 MCR01MZPJ113
 MCR01MZPJ121

 MCR01MZPJ125
 MCR01MZPJ203
 MCR01MZPJ751
 MCR01MZPJ822
 MCR03EZPJX103
 MCR03EZPFX1272
 MCR03EZPJ123

 MCR03EZPJ270
 MCR03EZPJ821
 MCR10EZPF1102
 MCR10EZPF2003
 MCR10EZPF2700
 MCR18EZPJ330
 RC0603F1473CS

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 RC1005F1182CS
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 RC1005F241CS
 RC1005F2431CS
 RC1005F3031CS
 RC1005F4321CS

 RC1005F4642CS
 RC1005F471CS
 RC1005F4751CS
 RC1005F4751CS
 RC1005F4751CS